MOSFET - Power, Single N-Channel, DFNW8

80 V, 1.56 mΩ, 287 A

NTMTS1D5N08MC

Features

- Small Footprint (8x8 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Power Tools, Battery Operated Vacuums
- UAV/Drones, Material Handling
- BMS/Storage, Home Automation

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	80	V	
Gate-to-Source Voltage	e	_	V _{GS}	±20	V
Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady	T _C = 25°C	۱ _D	287	A
Power Dissipation $R_{\theta JC}$ (Note 2)	State		P _D	250	W
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2)	Steady State	T _A = 25°C	Ι _D	33	A
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)	Sidle		P _D	3.3	W
Pulsed Drain Current	$T_{C} = 25^{\circ}C, t_{p} = 10 \ \mu s$		I _{DM}	3500	А
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +150	°C	
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 31 \text{ A}, L = 3 \text{ mH}$)			E _{AS}	1441	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	0.5	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	38	

1. Surface-mounted on FR4 board using a 1 in² pad size, 1 oz. Cu pad.

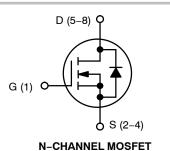
The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

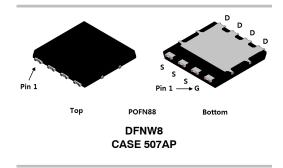


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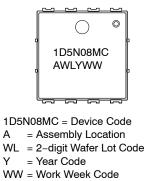
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
80 V	1.56 m Ω @ 10 V	287 A	
	4.0 mΩ @ 6 V	207 A	





MARKING DIAGRAM



ORDERING INFORMATION

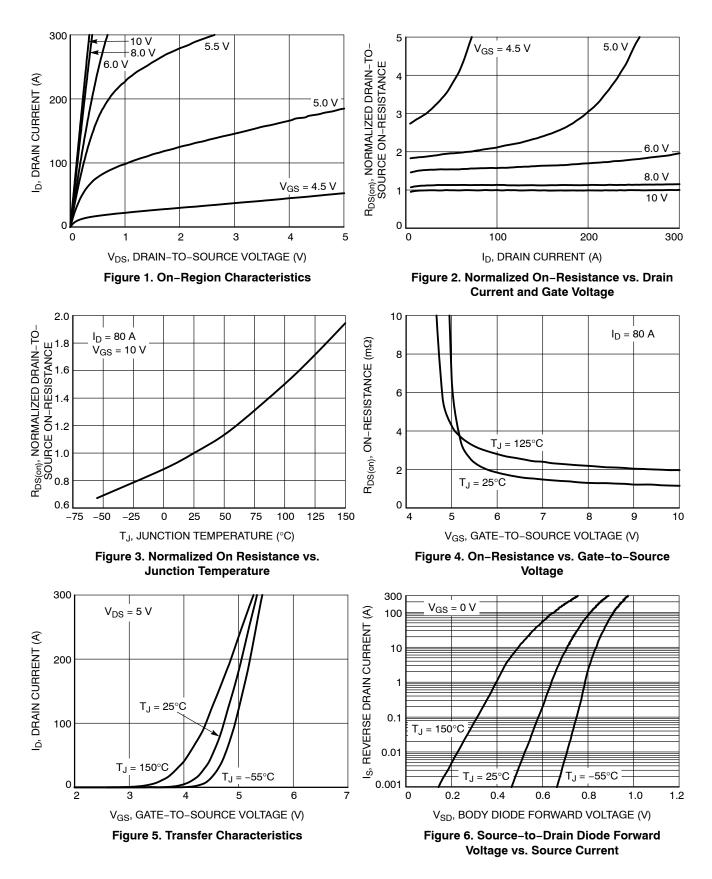
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

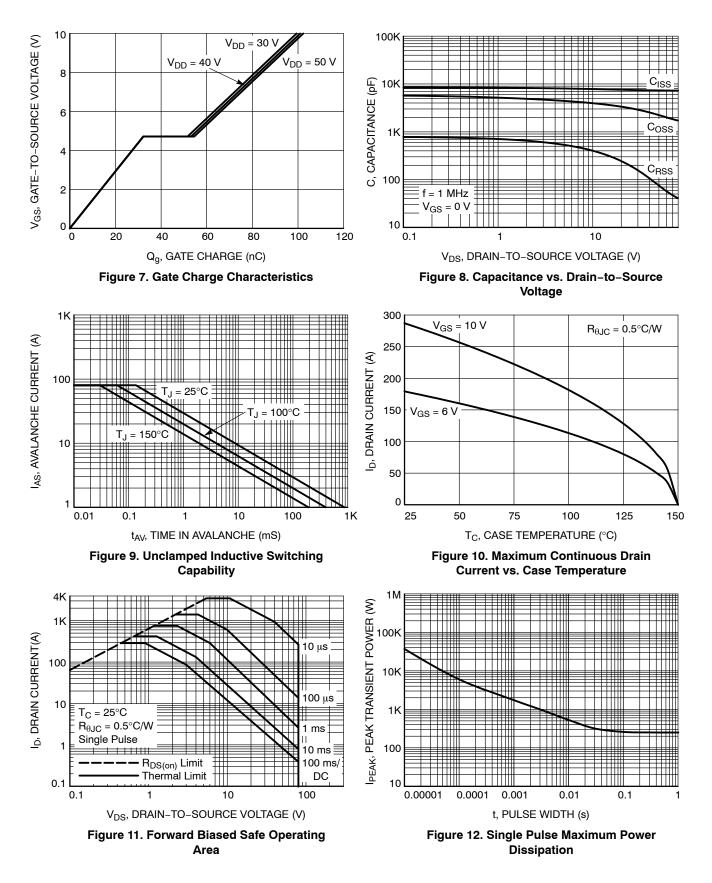
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = 250 \ \mu\text{A}$, ref to 25°C			82		mV/°C
Zero Gate Voltage Drain Current	I_{DSS} $V_{GS} = 0 V$, $T_J = 25^{\circ}C$			1	_		
		V _{DS} = 80 V	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	= 650 μA	2.0	3.0	4.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 650 μA, re	f to 25°C		-8.3		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 80 A		1.10	1.56	mΩ
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 6 V	I _D = 58 A		1.75	4.0	mΩ
Forward Transconductance	9 _{FS}	$V_{DS} = 5 \text{ V}, \text{ I}_D$	= 80 A		219		S
Gate Resistance	R _G	T _A = 25°	С		0.9		Ω
CHARGES, CAPACITANCES & GATE RESIST	ANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 40 V			7420	10,400	
Output Capacitance	C _{OSS}				2555	3600	pF
Reverse Transfer Capacitance	C _{RSS}				101	175	
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 40 V; I _D = 80 A			101	140	
Threshold Gate Charge	Q _{G(TH)}				20	28	nC
Gate-to-Source Charge	Q _{GS}				32		
Gate-to-Drain Charge	Q _{GD}				21		nC
Output Charge	Q _{OSS}				141		
Sync Charge	Q _{sync}				82		
Plateau Voltage	V _{plateau}				5		V
SWITCHING CHARACTERISTICS, V_{GS} = 10 V	' (Note 3)						
Turn-On Delay Time	t _{d(ON)}				30		
Rise Time	t _r	V _{GS} = 10 V, V _{DS}	_s = 40 V,		24		
Turn-Off Delay Time	t _{d(OFF)}	$I_{\rm D} = 80$ A, $R_{\rm G} = 6 \Omega$			69		ns
Fall Time	t _f				31		
DRAIN-SOURCE DIODE CHARACTERISTICS	5			-			-
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V, I_S = 2 A$ $V_{GS} = 0 V, I_S = 80 A$			0.7	1.2	.,
					0.8	1.3	V
Reverse Recovery Time	t _{RR}		200 A /		39	62	
Reverse Recovery Charge	Q _{RR}	I _F = 40 A, di/dt = 300 A/μs			89	142	ns
Reverse Recovery Time	t _{RR}		1000 11		31	50	1
Reverse Recovery Charge	Q _{RR}	I _F = 40 A, di/dt = 1000 A/μs			209	335	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

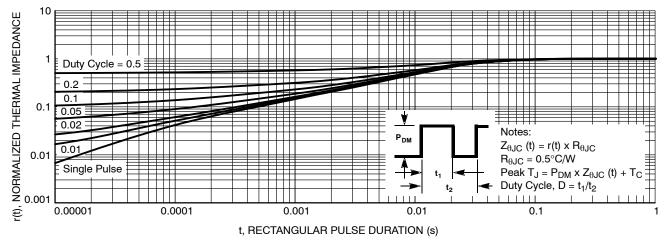


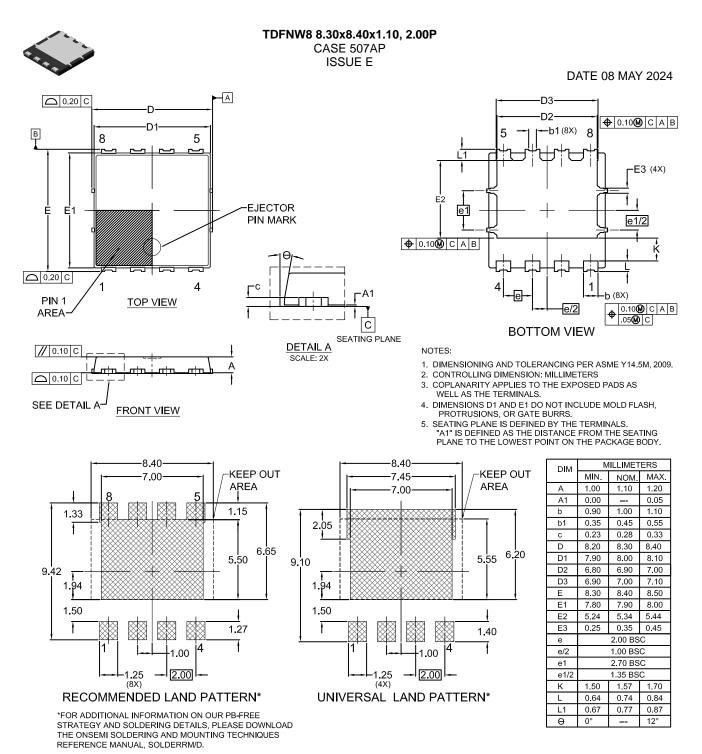
Figure 13. Transient Thermal Impedance

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMTS1D5N08MC	NTMTS 1D5N08MC	DFNW8 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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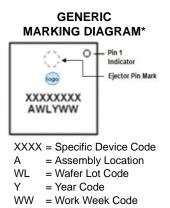
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DATE 08 MAY 2024



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

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